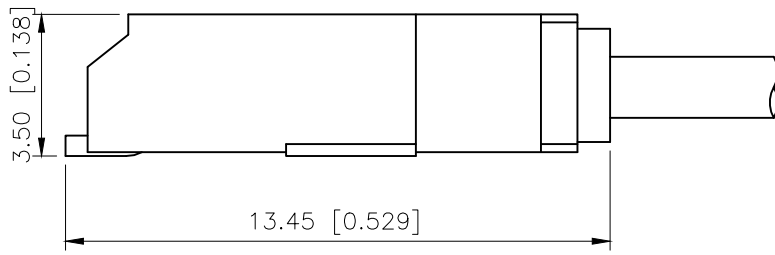
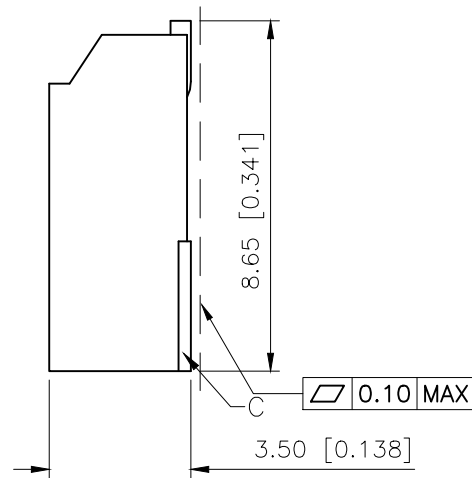
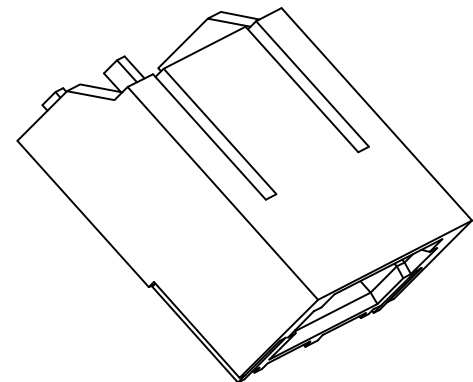
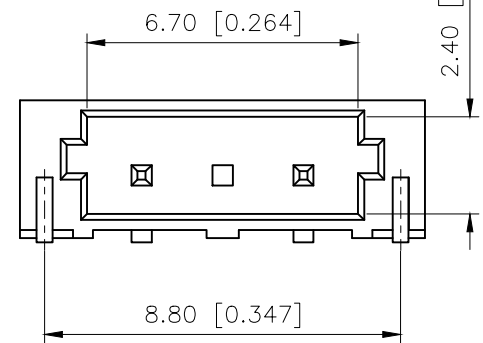
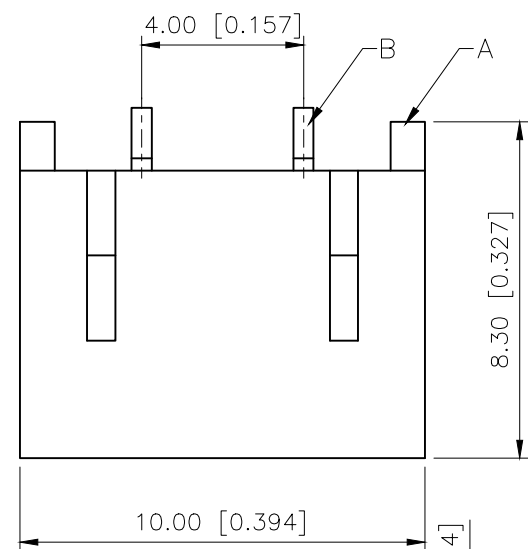
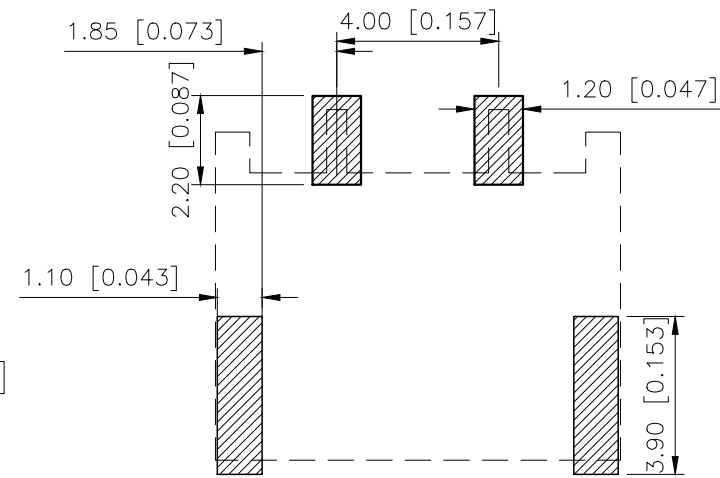


REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.2.28	阿树



Assembly Layout

Specifications:
Voltage rating: 600V AC/ DC
Current rating: 1A AC/DC
Withstanding voltage: 1700V AC/minute
Temperature range: -55° ~+105
Insulation resistance: ≥1000MΩ
Contact resistance: ≤20mΩ
After environmental testing:≤40mΩ



PCB LAYOUT

PART NO.:

X4001 W V-02-LP SN
① ② ③ ④ ⑤ ⑥ ⑦

- ①Series Number.
- ②Category:W-Wafer
- ③Welding Board Angle:F-Female
- ④Row No.-Pin No.:02 PIN
- ⑤Material:LP-LCP 94V-0
- ⑥Plating Category:SN-Bright Tin Plating

X4001WV-02-LPSN	LCP UL 94V-0	Phosphor Bronze	Tin-Plated	Brass	Tin-Plated
PART NO	Material	Material(Pin)	Finish(Pin)	Material (Solder Tab)	Finish (Solder Tab)

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树
CHECKED	
APPROVED	

VIEW:	
UNIT:	mm/in
SIZE:	A4

MODEL TYPE:	4.0mm BTB Connector
PART NO.:	X4001WV-02-LPSN
DWG NO.:	